


Fast Recovery Diodes (T-Modules), 40 A, 70 A, 85 A



D-55 (T-module)

FEATURES

- Fast recovery time characteristics
- Electrically isolated base plate
- 3500 V_{RMS} isolating voltage
- Standard JEDEC® package
- Simplified mechanical designs, rapid assembly
- Large creepage distances
- UL E78996 approved 
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

PRODUCT SUMMARY

| | |
|--------------------|-----------------------|
| I _{F(AV)} | 40 A, 70 A, 85 A |
| Type | Modules - Diode, Fast |

DESCRIPTION

The series of T-modules uses fast recovery power diodes in a single diode configuration. The semiconductors are electrically isolated from the metal base, allowing common heatsink and compact assemblies to be built.

These single diode modules can be used in conjunction with the thyristor modules as a freewheel diode. Application includes self-commutated inverters, DC choppers, motor control, inductive heating and electronic welders. These modules are intended for those applications where very fast recovery characteristics are required and for general power switching applications.

MAJOR RATINGS AND CHARACTERISTICS

| SYMBOL | CHARACTERISTICS | T40HFL | T70HFL | T85HFL | UNITS |
|---------------------|-----------------|-------------|--------|--------|------------------|
| I _{F(AV)} | | 40 | 70 | 85 | A |
| | T _C | 70 | 70 | 70 | °C |
| I _{F(RMS)} | | 63 | 110 | 133 | A |
| I _{FSM} | 50 Hz | 475 | 830 | 1300 | A |
| | 60 Hz | 500 | 870 | 1370 | |
| I ² t | 50 Hz | 1130 | 3460 | 8550 | A ² s |
| | 60 Hz | 1030 | 3160 | 7810 | |
| V _{RRM} | Range | 100 to 1000 | | | V |
| t _{rr} | Range | 200 to 1000 | | | ns |
| T _J | Range | -40 to +125 | | | °C |



ELECTRICAL SPECIFICATIONS

| VOLTAGE RATINGS | | | | | |
|---|--------------|----------------------|---|---|--|
| TYPE NUMBER | VOLTAGE CODE | t _{rr} CODE | V _{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V | V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V | I _{RRM} MAXIMUM AT T _J = 25 °C μA |
| VS_T40HFL.. VS_T70HFL.. VS_T85HFL.. | 10 | S02, S05, S10 | 100 | 150 | 100 |
| | 20 | S02, S05, S10 | 200 | 300 | |
| | 40 | S02, S05, S10 | 400 | 500 | |
| | 60 | S02, S05, S10 | 600 | 700 | |
| | 80 | S05, S10 | 800 | 900 | |
| | 100 | S05, S10 | 1000 | 1100 | |

| FORWARD CONDUCTION | | | | | | | | |
|---|---------------------|--|-----------------------------------|---|--------|--------|--------|-------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | | VALUES | | | UNITS |
| | | | | | T40HFL | T70HFL | T85HFL | |
| Maximum average forward current at case temperature | I _{F(AV)} | 180° conduction, half sine wave | | | 40 | 70 | 85 | A |
| Maximum RMS forward current | I _{F(RMS)} | | | | 63 | 110 | 133 | A |
| Maximum peak, one-cycle forward, non-repetitive surge current | I _{FSM} | t = 10 ms | No voltage reappplied | Sinusoidal half wave, initial T _J = T _J maximum | 475 | 830 | 1300 | A |
| | | t = 8.3 ms | | | 500 | 870 | 1370 | |
| | | t = 10 ms | 100 % V _{RRM} reappplied | | 400 | 700 | 1100 | |
| | | t = 8.3 ms | | | 420 | 730 | 1150 | |
| Maximum I ² t for fusing | I ² t | t = 10 ms | No voltage reappplied | | 1130 | 3460 | 8550 | A ² s |
| | | t = 8.3 ms | | | 1030 | 3160 | 7810 | |
| | | t = 10 ms | 100 % V _{RRM} reappplied | | 800 | 2450 | 6050 | |
| | | t = 8.3 ms | | | 730 | 2230 | 5520 | |
| Maximum I ² √t for fusing | I ² √t | t = 0.1 ms to 10 ms, no voltage reappplied | | | 11 300 | 34 600 | 85 500 | A ² √s |
| Low level value of threshold voltage | V _{F(TO)1} | T _J = 25 °C, (16.7 % × π × I _{F(AV)}) < I < π × I _{F(AV)} | | | 0.82 | 0.87 | 0.84 | V |
| High level value of threshold voltage | V _{F(TO)2} | T _J = 25 °C, (I > π × I _{F(AV)}) | | | 0.84 | 0.90 | 0.86 | |
| Low level value of forward slope resistance | r _{f1} | T _J = 25 °C, (16.7 % × π × I _{F(AV)}) < I < π × I _{F(AV)} | | | 7.0 | 2.77 | 2.15 | mΩ |
| High level value of forward slope resistance | r _{f2} | T _J = 25 °C, (I > π × I _{F(AV)}) | | | 6.8 | 2.67 | 2.07 | |
| Maximum forward voltage drop | V _{FM} | I _{FM} = π × I _{F(AV)} , T _J = 25 °C, t _p = 400 μs square wave Average power = V _{F(TO)} × I _{F(AV)} + r _f × (I _{F(RMS)}) ² | | | 1.60 | 1.73 | 1.55 | V |

| REVERSE RECOVERY CHARACTERISTICS | | | | | | | | | | | | |
|----------------------------------|-----------------|---|--------|-----|------|--------|-----|------|--------|-----|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS ⁽¹⁾ | T40HFL | | | T70HFL | | | T85HFL | | | UNITS |
| | | | S02 | S05 | S10 | S02 | S05 | S10 | S02 | S05 | S10 | |
| Maximum reverse recovery time | t _{rr} | T _J = 25 °C, -di _F /dt = 100 A/μs I _F = 1 A to V _R = 30 V | 70 | 110 | 270 | 70 | 110 | 270 | 80 | 120 | 290 | ns |
| | | T _J = 25 °C, -di _F /dt = 25 A/μs I _{FM} = π × rated I _{F(AV)} , V _R = -30 V | 200 | 500 | 1000 | 200 | 500 | 1000 | 200 | 500 | 1000 | |
| Maximum reverse recovery charge | Q _{rr} | T _J = 25 °C, -di _F /dt = 100 A/μs I _F = 1 A to V _R = 30 V | 0.25 | 0.4 | 1.35 | 0.25 | 0.4 | 1.35 | 0.3 | 0.6 | 1.6 | μC |
| | | T _J = 25 °C, -di _F /dt = 25 A/μs I _{FM} = π × rated I _{F(AV)} , V _R = -30 V | 0.55 | 2.0 | 8.0 | 0.6 | 2.1 | 8.5 | 0.8 | 3.5 | 1.5 | |

Note

⁽¹⁾ Tested on LEM 300 A diodometer tester



| BLOCKING | | | | | | |
|--------------------------------------|------------|--|--------|--------|--------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | T40HFL | T70HFL | T85HFL | UNITS |
| Maximum peak reverse leakage current | I_{RRM} | $T_J = 125\text{ }^\circ\text{C}$ | 20 | | | mA |
| RMS isolation voltage | V_{ISOL} | 50 Hz, circuit to base, all terminals shorted, $T_J = 25\text{ }^\circ\text{C}$, $t = 1\text{ s}$ | 3500 | | | V |

| THERMAL AND MECHANICAL SPECIFICATIONS | | | | | | |
|--|--------------------|---|-------------------------------------|----------------|----|-----|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS | | |
| Junction operating temperature range | T_J | | -40 to +125 | °C | | |
| Storage temperature range | T_{Stg} | | -40 to +150 | | | |
| Maximum internal thermal resistance, junction to case per module | T40HFL | DC operation | 0.85 | K/W | | |
| | T70HFL | | 0.53 | | | |
| | T85HFL | | 0.46 | | | |
| Thermal resistance, case to heatsink per module | R_{thCS} | Mounting surface, flat, smooth and greased | 0.2 | | | |
| Mounting torque $\pm 10\%$ | base to heatsink | Non-lubricated threads | M3.5 mounting screws ⁽¹⁾ | 1.3 $\pm 10\%$ | Nm | |
| | busbar to terminal | | M5 screws terminals | 3 $\pm 10\%$ | | |
| Approximate weight | | See dimensions - link at the end of datasheet | | 54 | g | |
| | | | | | 19 | oz. |
| Case style | | | D-55 (T-module) | | | |

Note

⁽¹⁾ A mounting compound is recommended and the torque should be rechecked after a period of about 3 hours to allow for the spread of the compound

| ΔR CONDUCTION | | | | | | | | | | | |
|-----------------------|--|------|------|------|------|---|------|------|------|------|-------|
| DEVICES | SINUSOIDAL CONDUCTION AT T_J MAXIMUM | | | | | RECTANGULAR CONDUCTION AT T_J MAXIMUM | | | | | UNITS |
| | 180° | 120° | 90° | 60° | 30° | 180° | 120° | 90° | 60° | 30° | |
| T40HFL | 0.06 | 0.08 | 0.10 | 0.14 | 0.24 | 0.05 | 0.08 | 0.10 | 0.15 | 0.24 | K/W |
| T70HFL | 0.05 | 0.06 | 0.08 | 0.11 | 0.19 | 0.04 | 0.06 | 0.08 | 0.12 | 0.19 | |
| T85HFL | 0.04 | 0.05 | 0.06 | 0.09 | 0.15 | 0.03 | 0.05 | 0.07 | 0.09 | 0.15 | |

Note

The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

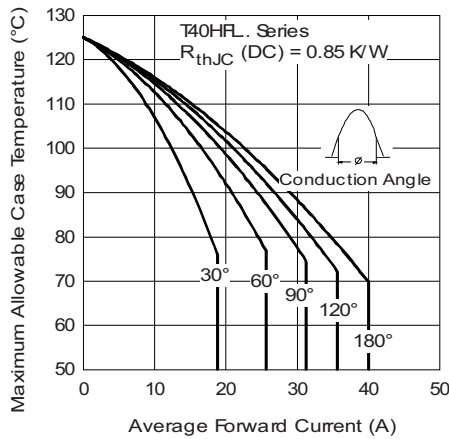


Fig. 1 - Current Ratings Characteristics

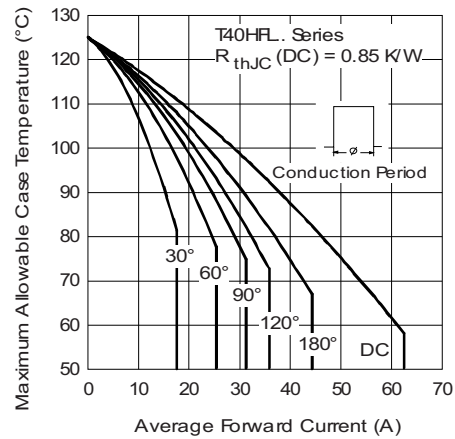


Fig. 2 - Current Ratings Characteristics

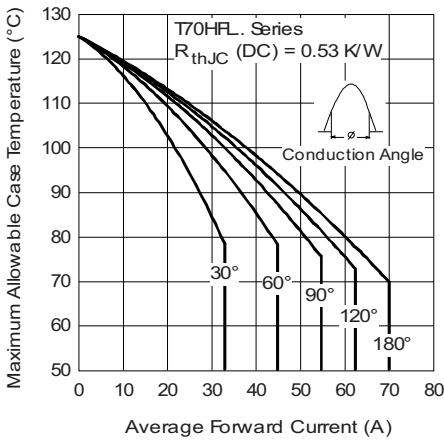


Fig. 3 - Current Ratings Characteristics

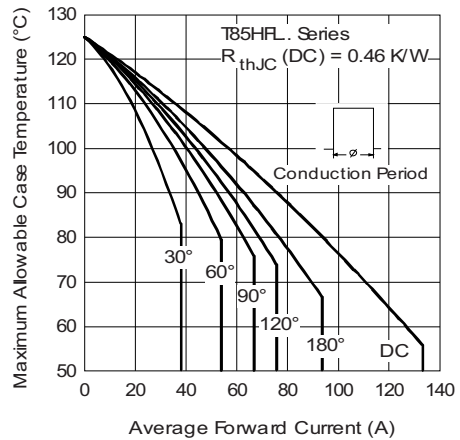


Fig. 6 - Current Ratings Characteristics

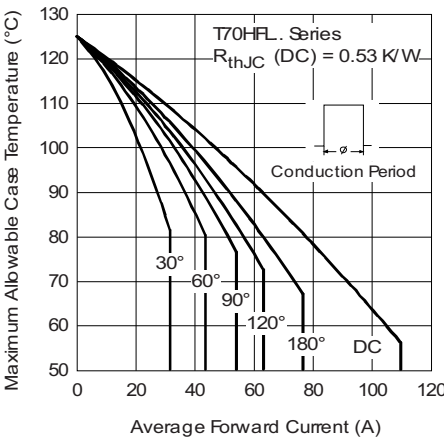


Fig. 4 - Current Ratings Characteristics

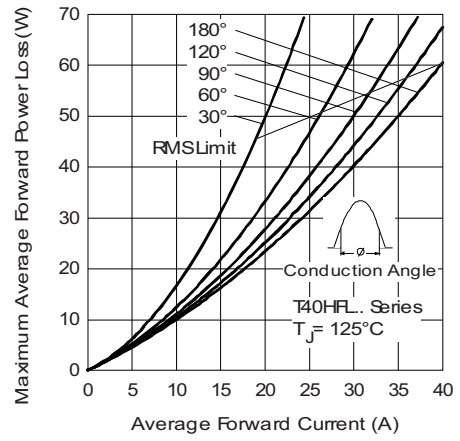


Fig. 7 - Forward Power Loss Characteristics

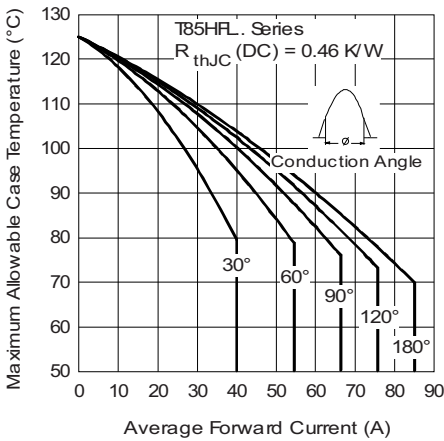


Fig. 5 - Current Ratings Characteristics

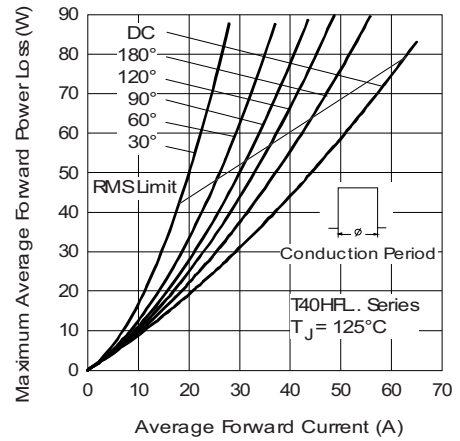


Fig. 8 - Forward Power Loss Characteristics

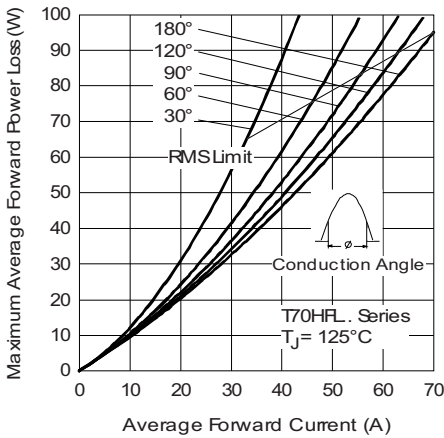


Fig. 9 - Forward Power Loss Characteristics

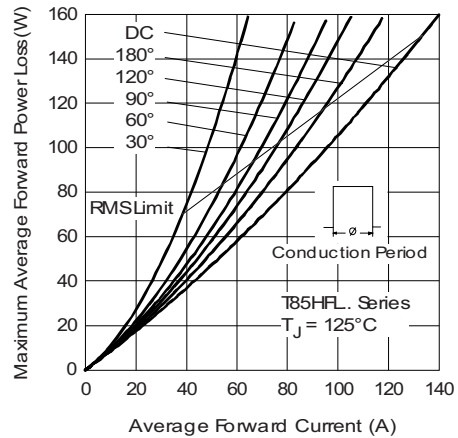


Fig. 12 - Forward Power Loss Characteristics

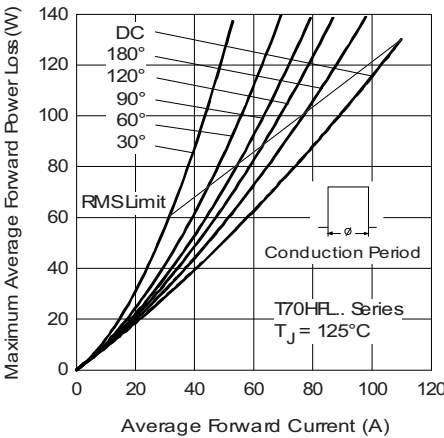


Fig. 10 - Forward Power Loss Characteristics

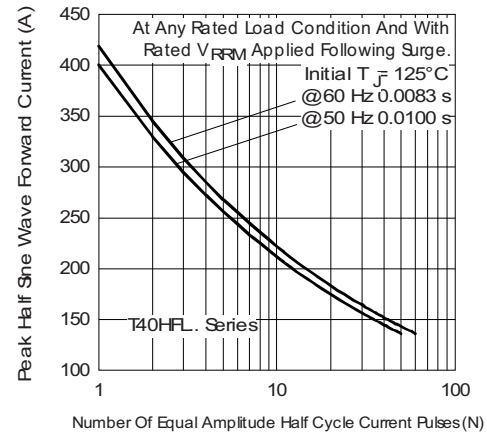


Fig. 13 - Maximum Non-Repetitive Surge Current

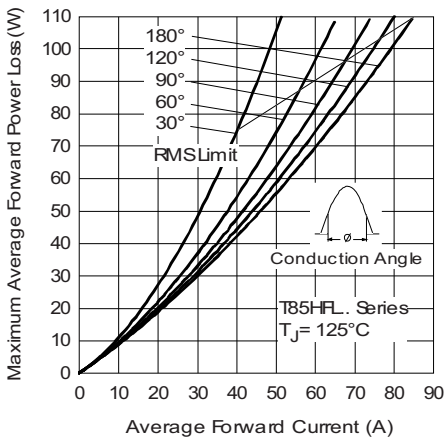


Fig. 11 - Forward Power Loss Characteristics

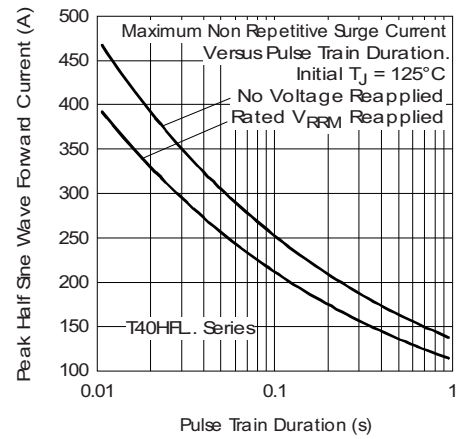


Fig. 14 - Maximum Non-Repetitive Surge Current

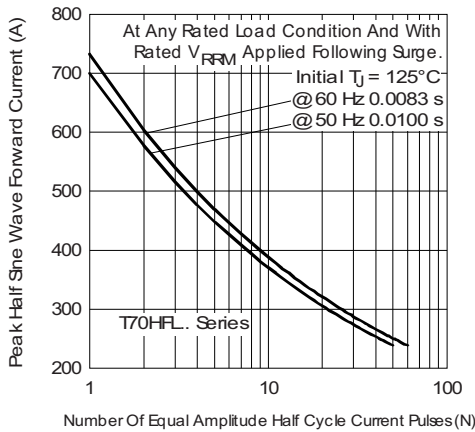


Fig. 15 - Maximum Non-Repetitive Surge Current

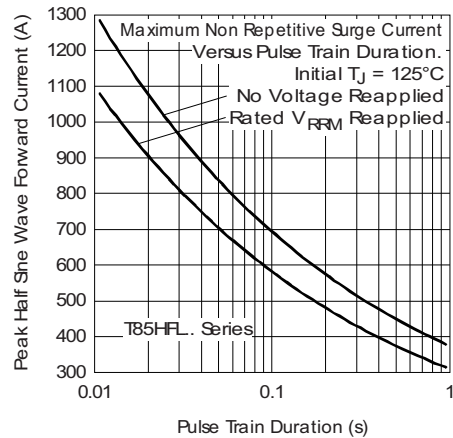


Fig. 18 - Maximum Non-Repetitive Surge Current

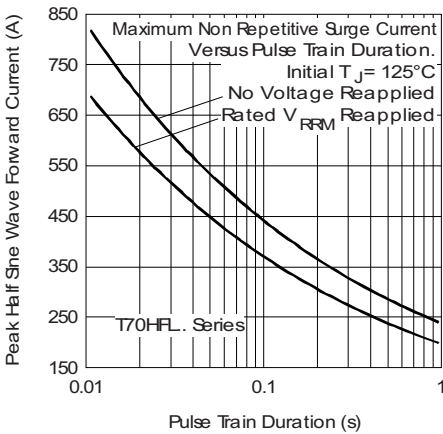


Fig. 16 - Maximum Non-Repetitive Surge Current

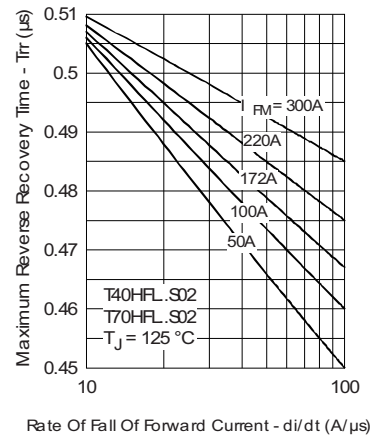


Fig. 19 - Recovery Time Characteristics

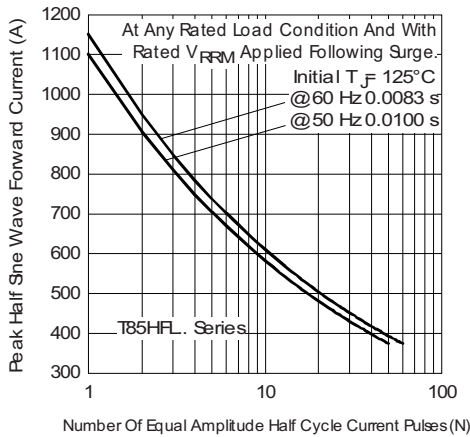


Fig. 17 - Maximum Non-Repetitive Surge Current

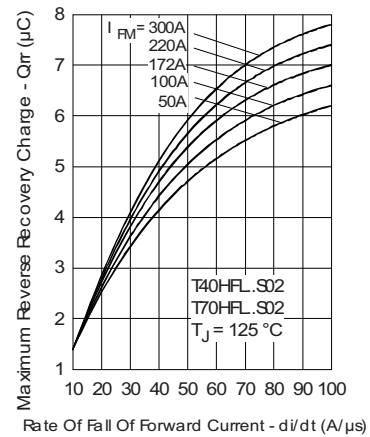


Fig. 20 - Recovery Charge Characteristics

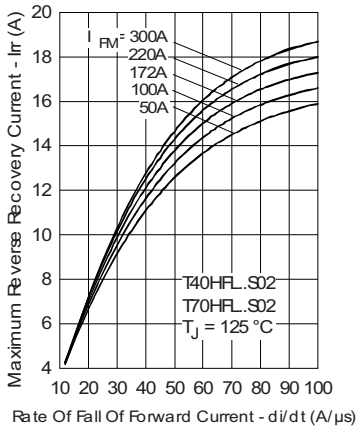


Fig. 21 - Recovery Current Characteristics

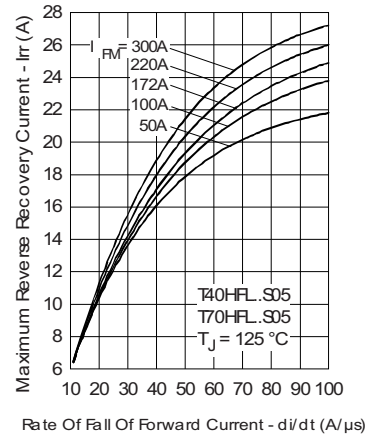


Fig. 24 - Recovery Current Characteristics

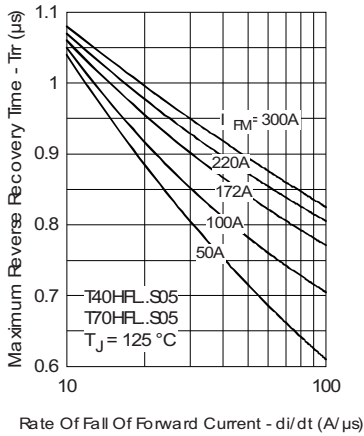


Fig. 22 - Recovery Time Characteristics

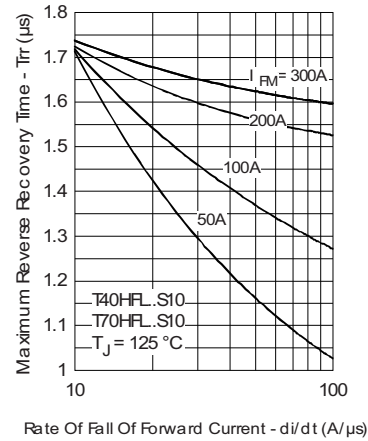


Fig. 25 - Recovery Time Characteristics

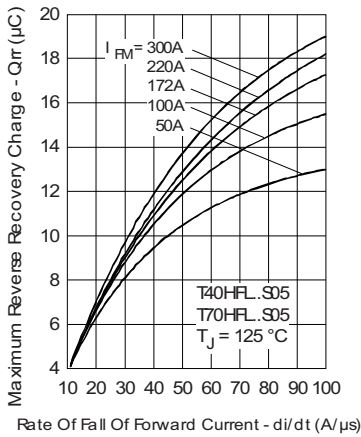


Fig. 23 - Recovery Charge Characteristics

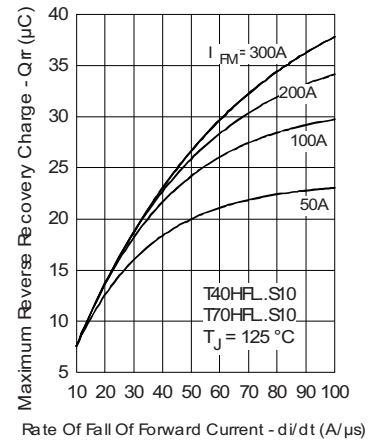


Fig. 26 - Recovery Charge Characteristics

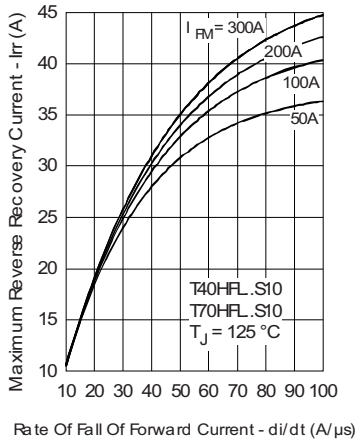


Fig. 27 - Recovery Current Characteristics

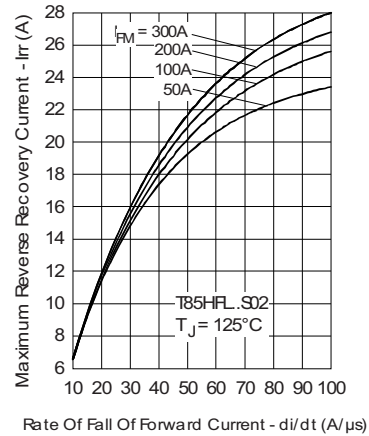


Fig. 30 - Recovery Current Characteristics

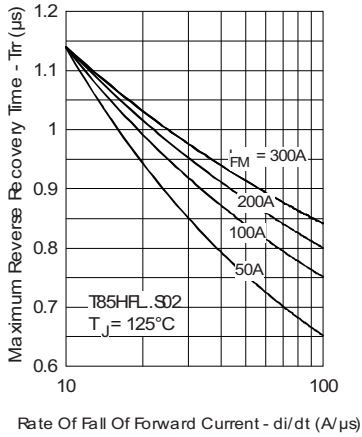


Fig. 28 - Recovery Time Characteristics

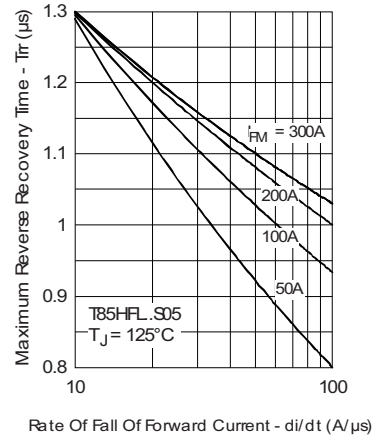


Fig. 31 - Recovery Time Characteristics

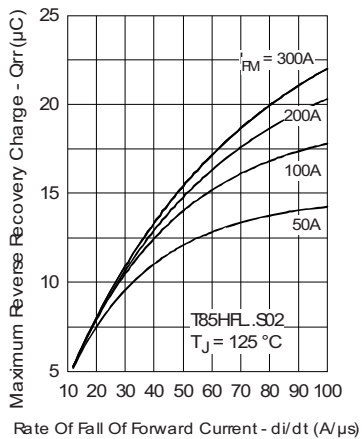


Fig. 29 - Recovery Charge Characteristics

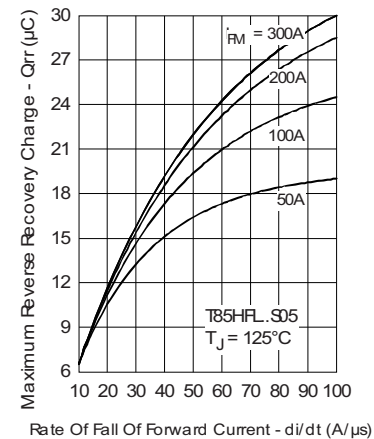


Fig. 32 - Recovery Charge Characteristics

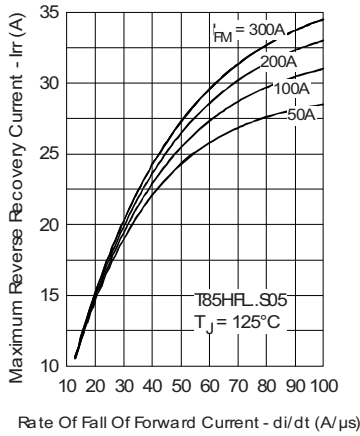


Fig. 33 - Recovery Current Characteristics

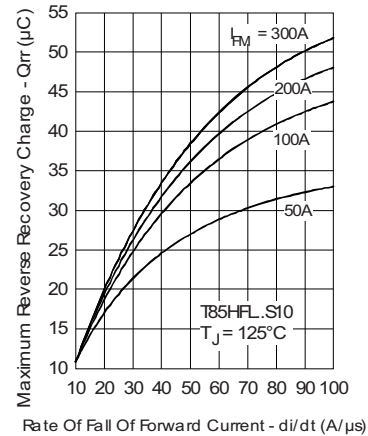


Fig. 35 - Recovery Charge Characteristics

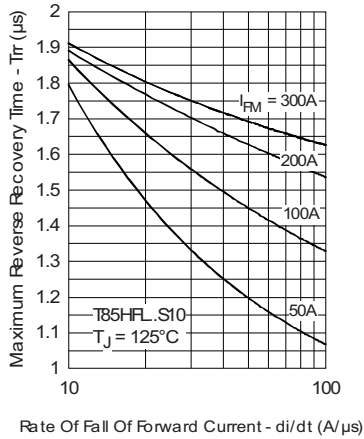


Fig. 34 - Recovery Time Characteristics

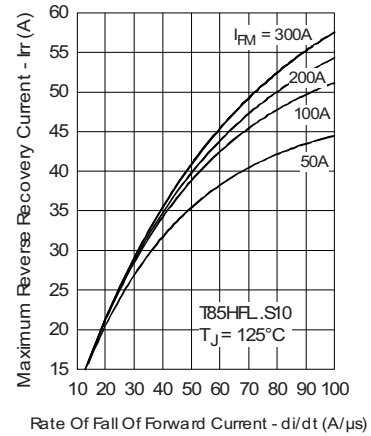


Fig. 36 - Recovery Current Characteristics

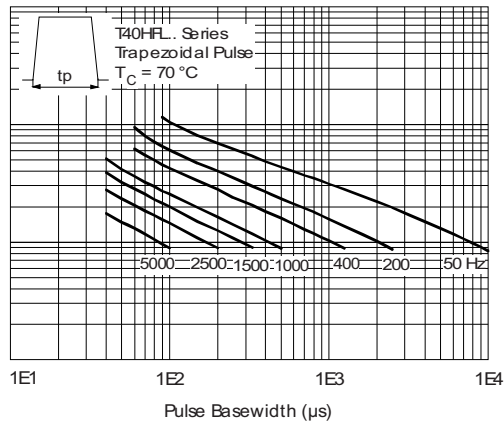
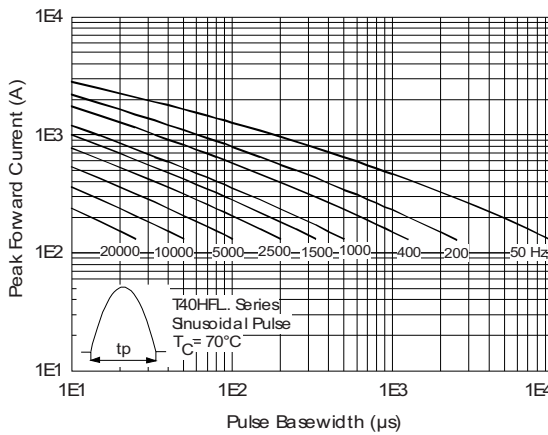


Fig. 37 - Frequency Characteristics

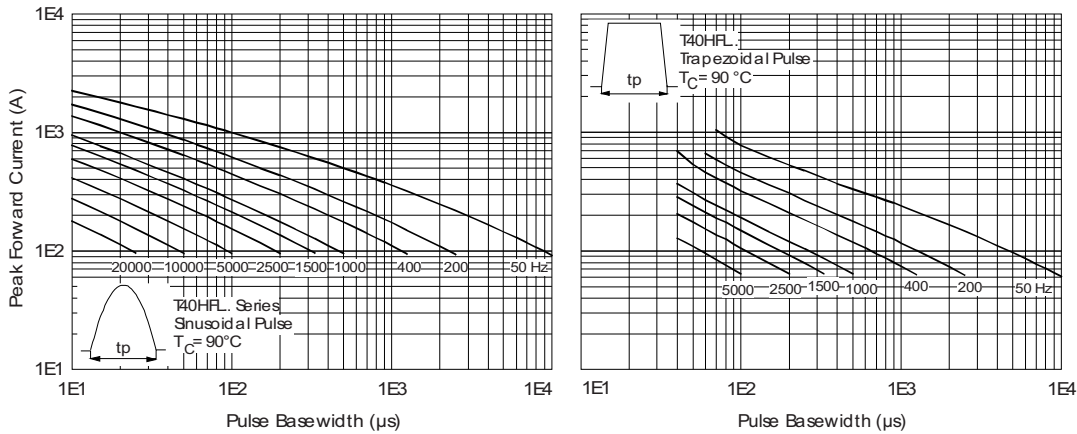


Fig. 38 - Frequency Characteristics

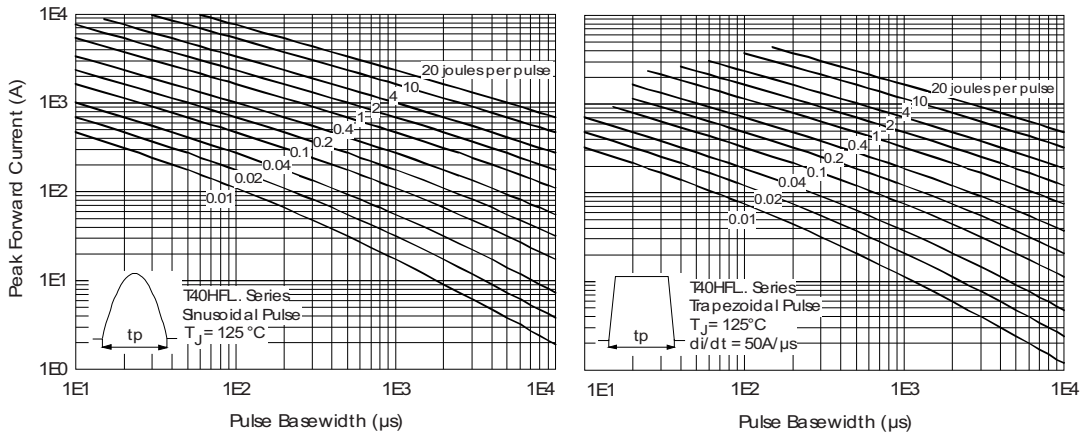


Fig. 39 - Maximum Forward Energy Power Loss Characteristics

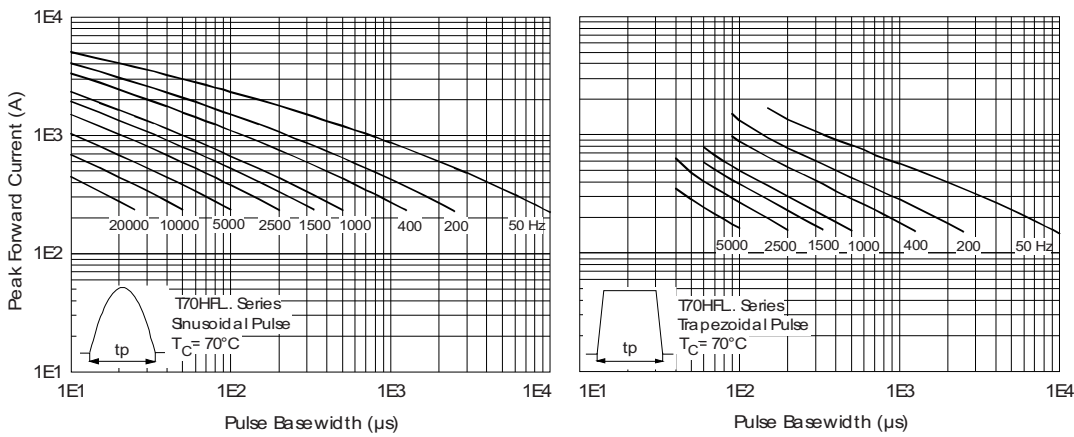


Fig. 40 - Frequency Characteristics

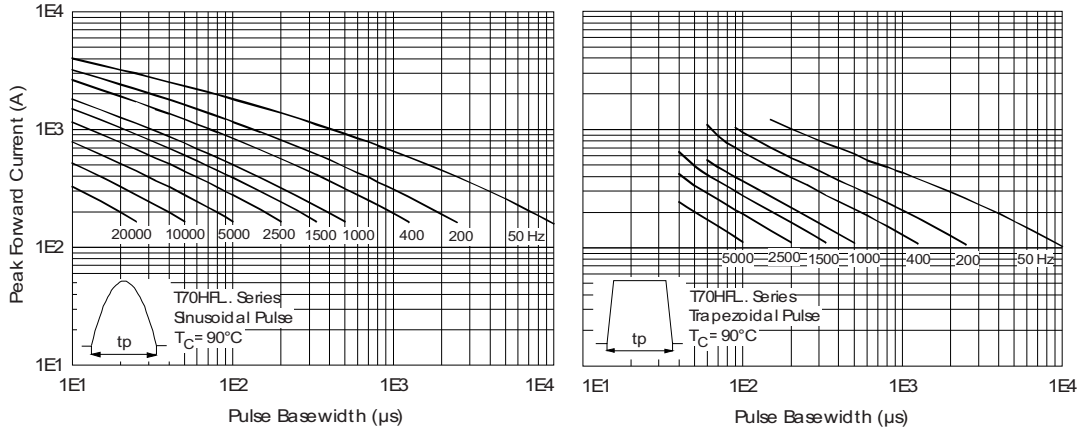


Fig. 41 - Frequency Characteristics

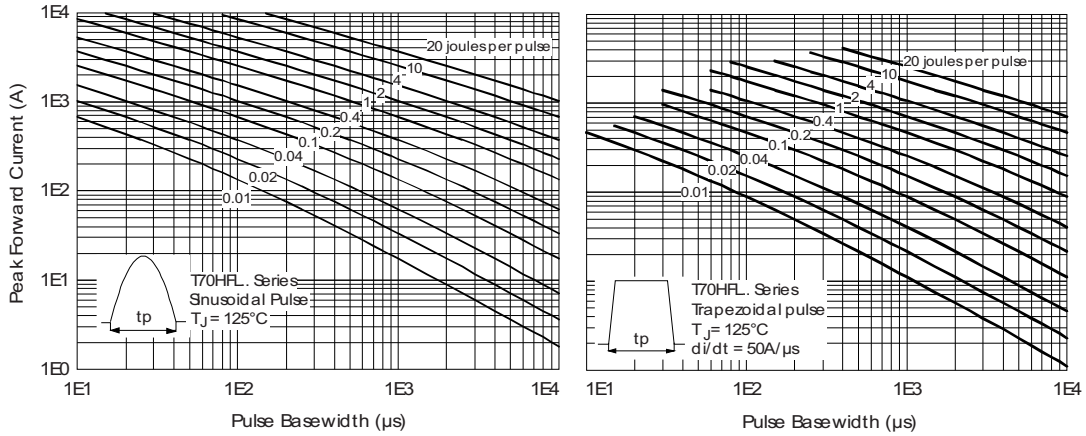


Fig. 42 - Maximum Forward Energy Power Loss Characteristics

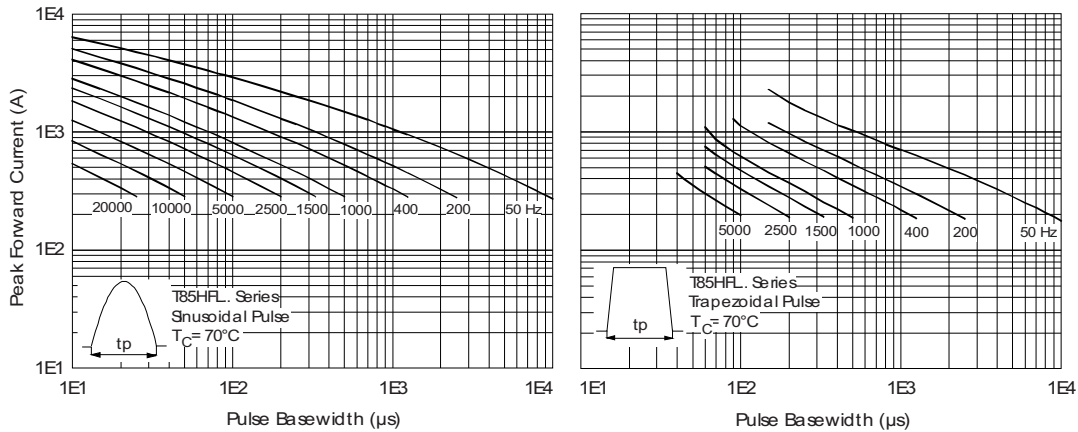


Fig. 43 - Frequency Characteristics

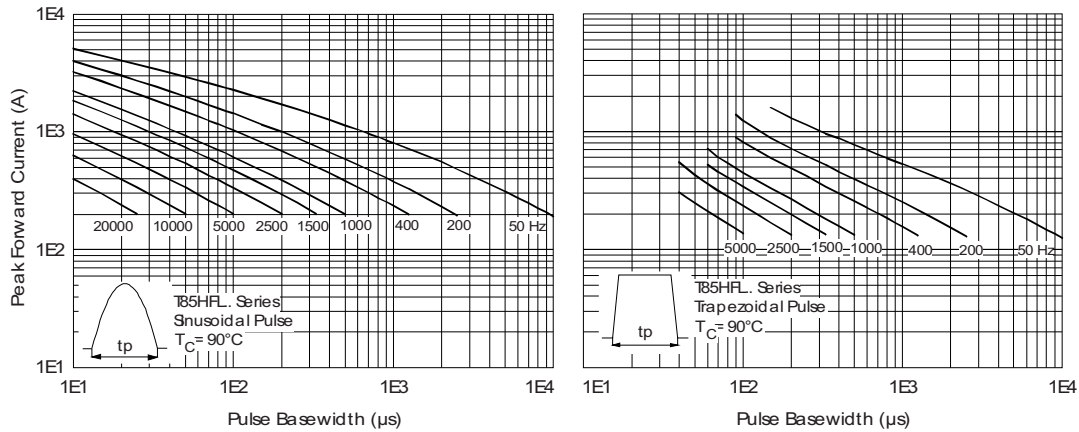


Fig. 44 - Frequency Characteristics

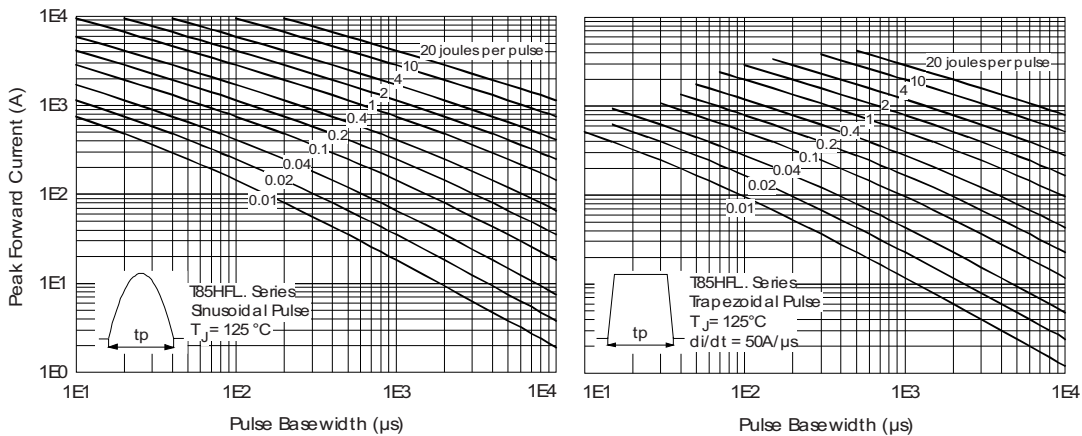


Fig. 45 - Maximum Forward Energy Power Loss Characteristics

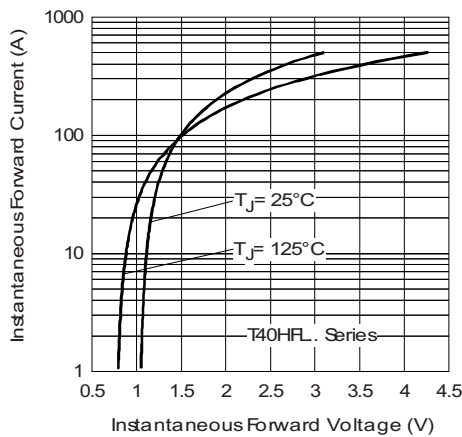


Fig. 46 - Forward Voltage Drop Characteristics

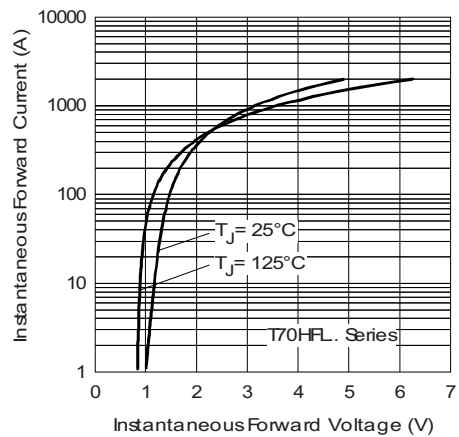


Fig. 47 - Forward Voltage Drop Characteristics

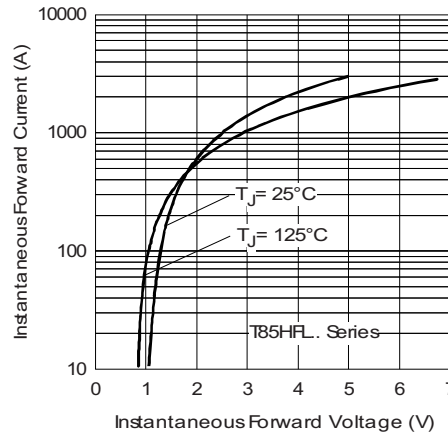


Fig. 48 - Forward Voltage Drop Characteristics

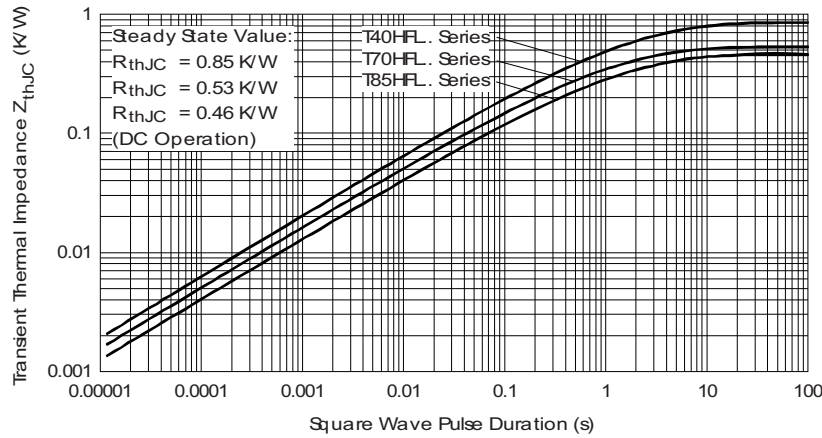
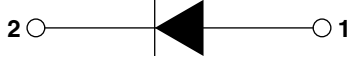


Fig. 49 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE

| | | | | | | |
|-------------|------------|--|---------------------|------------|---------------|------------|
| Device code | VS- | T | 40 | HFL | 100 | S10 |
| | (1) | (2) | (3) | (4) | (5) | (6) |
| | 1 | - Vishay Semiconductors product | | | | |
| | 2 | - Module type | | | | |
| | 3 | - Current rating | 40 = 40 A (average) | | | |
| | 4 | - Fast recovery diode | 70 = 70 A (average) | | | |
| | 5 | - Voltage code x 10 = V _{RRM} | 85 = 85 A (average) | | | |
| | 6 | - t _{rr} code | | | S02 = 200 ns | |
| | | | | | S05 = 500 ns | |
| | | | | | S10 = 1000 ns | |



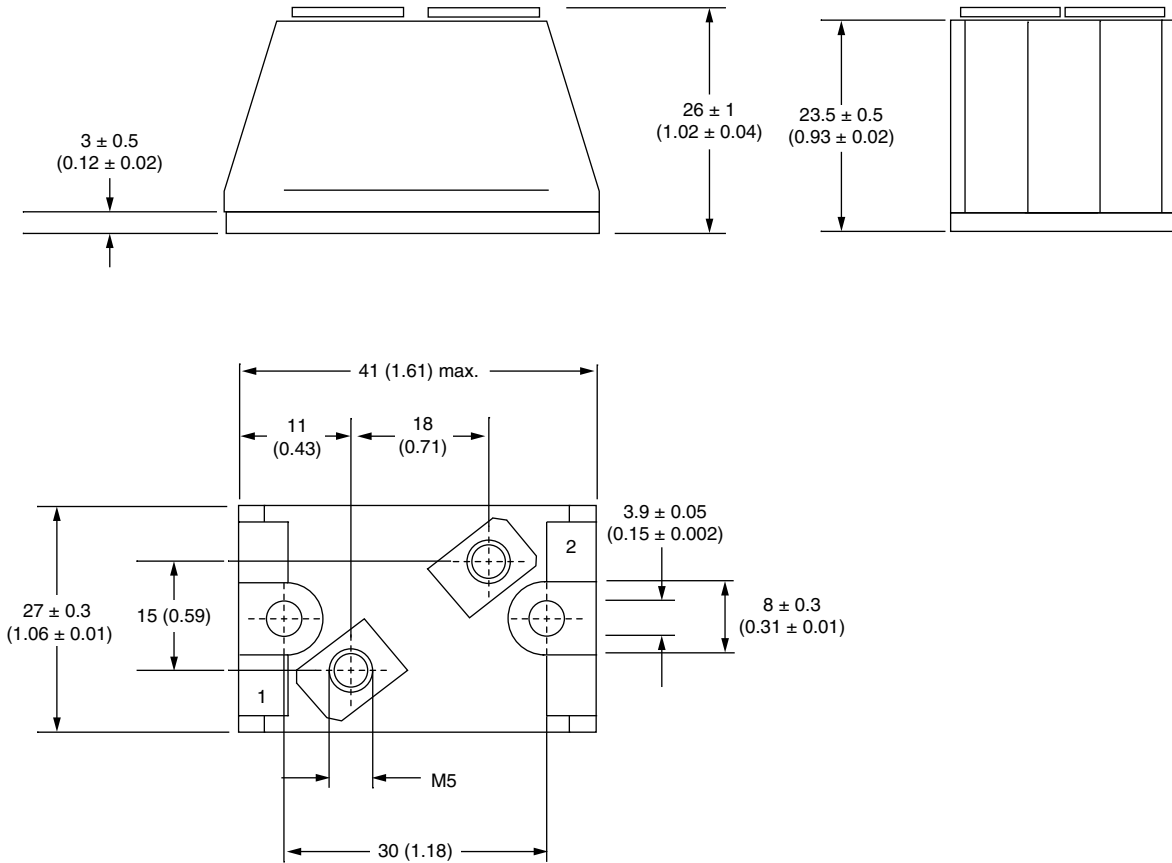
| CIRCUIT CONFIGURATION | | |
|-----------------------|----------------------------|---|
| CIRCUIT | CIRCUIT CONFIGURATION CODE | CIRCUIT DRAWING |
| Single switch diode | N/A |  |

| LINKS TO RELATED DOCUMENTS | |
|----------------------------|--|
| Dimensions | www.vishay.com/doc?95313 |



D-55 T-Module Diode Standard and Fast Recovery

DIMENSIONS in millimeters (inches)



Note

- 1 = Anode
- 2 = Cathode



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.